

A model for grinding forces prediction in ultrasonic vibration assisted grinding of SiCp/Al composites

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Abstract Ultrasonic vibration assisted grinding is an advanced method for machining difficult-to-process materials such as SiCp/Al composites. This paper presents a mechanics model for predicting grinding forces in ultrasonic vibration assisted grinding of SiCp/Al composites. It consists of side grinding force model and end grinding force model. In side grinding force model, the major components are the normal force and tangential force in which the analytical expressions for the chip formation force based on Rayleigh's probability density function, the frictional force, and the particle fracture force based on Griffith theory are established, respectively. In contrast, the axial force developed based on the indentation theory is the major component in end grinding force model. The coefficients in the proposed grinding force model were obtained through two groups of orthogonal experiments. Based on the mechanics prediction model, the relationship between grinding forces and process variables were predicted. At last, two groups of single factor experiments were conducted to verify the proposed grinding force model and experimental results were found to agree well with predicted results.

Keywords Ultrasonic vibration assisted grinding · SiCp/Al composites · Grinding force · Prediction model

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1 Introduction

Superior properties such as high specific strength and specific stiffness make SiCp/Al composites highly competitive against conventional materials and are widely used in aerospace, automobile, and other fields. However, the addition of SiC particles makes SiCp/Al composites hard to be manufactured because of its extreme abrasive properties. This has limited the practical application of SiCp/Al composites. Therefore, it is necessary to develop a nontraditional machining process to meet the demand of SiCp/Al composite machining. Ultrasonic vibration assisted grinding is a combination of two ordinary material remove processes, i.e., grinding and ultrasonic machining, during which ultrasonic vibration is applied to the grinding tool. Compared with other traditional machining methods, this machining method has many advantages, such as lower grinding force, higher surface quality, higher machining efficiency, and longer tool life [1–5].

The machining of SiCp/Al composites has been extensively studied experimentally and numerically to assess tool wear, tool life, surface roughness, and subsurface damage. There are a few studies focused on the prediction model of cutting forces in cutting or conventional grinding of metal matrix composites (MMCs) [6–12]. Kishawy et al. [6] presented an energy-based analytical force model in orthogonal cutting of SiCp/Al composites to predict cutting forces. In this model, the energy for interfacial debonding is quantified. Pramanik et al. [7] developed a mechanics model for cutting force prediction when a machining aluminum-based SiC/Al₂O₃ particle reinforced MMCs. In this model, cutting force is considered to consist of components due to chip formation, ploughing, particle fracture, and displacement. Davim [8] presented a preliminary experimental study based on Merchant theory, in which the chip compression ratio, shear angle, shear strain, shear strain rate, normal stress, and shear stress were evaluated. Dabade

et al. [9] developed a cutting force prediction model in turning SiCp/Al composites, in which the frictional characteristics of chip–tool and work–tool interfaces were considered. Sikder et al. [10] presented an analytical prediction force model in turning SiCp/Al composites. In this model, the frictional force along the chip–tool interface was modeled. Du et al. [11] developed an analytical cutting force model for conventional grinding SiCp/Al composites based on the energy theory of particle fracture and Griffith theory of fracture. But, in this model, only side grinding force was modeled. Ghandehariun et al. [12] presented a novel analytical force model in machining MMCs which was based on the calculation of power consumption in different parts of the cutting system. The plastic deformations, different types of friction at various interfaces, and debonding and fracture of reinforcements were considered in the model.

It is noted that, at present, no publications are available on grinding force model for ultrasonic vibration assisted grinding SiCp/Al composites. Therefore, this paper develops a numerical model for grinding force prediction in ultrasonic vibration assisted grinding of SiCp/Al composites to help optimize process variables.

The paper is organized into five sections. Following this introduction section, Sect. 2 describes the grinding force model development step by step. In Sect. 3, experimental setup is introduced. The coefficients in the proposed model is determined through two groups of orthogonal experiments, predicted influences of process variables on grinding forces are discussed, and two groups of single factor experiments were conducted to verify the proposed grinding force model in Sect. 4. Conclusions are contained in Sect. 5.

2 Development of grinding force model

Ultrasonic vibration assisted grinding contains two different machining modes: side grinding and end grinding, as shown in Fig. 1. Then, grinding force in ultrasonic vibration assisted grinding of SiCp/Al composites can be divided into two parts: the side grinding force and the end grinding force. In side grinding process, the normal force and the tangential force are the major components of the side grinding force. In contrast, in end grinding process, the major component of the end grinding force is the axial force. Side grinding force model and end grinding force model will be developed respectively in Sects. 2.2 and 2.3.

The development of the grinding force model is based on the following several major assumptions and simplifications:

1. The diamond abrasive grains are assumed to be rigid cones with the same generatrix s and semi-angle $\theta=60^\circ$, as shown in Fig. 2.
2. All diamond abrasive grains uniformly distribute in the abrasive portion of the grinding tool, and all of them take

part in cutting process during each ultrasonic vibration cycle.

3. During the development of the grinding force model, only stable machining process is taken into account; i.e., the cutting in and out processes of the grinding tool are neglected.
4. Ultrasonic vibration amplitude A and frequency f in the machining process are in a stable condition; i.e., both of them keep unchanged during machining.

2.1 Kinematic analysis of abrasive grains in ultrasonic vibration assisted grinding

Since the abrasive grains, both on side and end surfaces of the grinding tool, vibrate at an amplitude A and a frequency f while feeding with a feedrate v_f and an angular speed ω , the motion and speed of a single abrasive grain in the x, y, and z directions can be expressed as follows:

$$s_g(t) = \begin{pmatrix} x_g(t) \\ y_g(t) \\ z_g(t) \end{pmatrix} = \begin{pmatrix} v_f t + R_o \sin(\omega t) \\ R_o \cos(\omega t) \\ A \sin(2\pi f t) \end{pmatrix} \quad (1)$$

$$v_g(t) = s'_g(t) = \begin{pmatrix} x'_g(t) \\ y'_g(t) \\ z'_g(t) \end{pmatrix} = \begin{pmatrix} v_f + \omega R_o \cos(\omega t) \\ -\omega R_o \sin(\omega t) \\ 2\pi f A \cos(2\pi f t) \end{pmatrix} \quad (2)$$

where R_i and R_o are the inner and outer radii of the grinding tool, respectively.

The motion trajectories of grains on side and end surfaces of the grinding tool are shown in Fig. 3.

2.2 Development of side grinding force model

Side grinding force can be subdivided into chip formation force, ploughing force, friction force, and fracture force of silicon carbide particles (SiCp) [6, 7, 11, 13, 14]. The ploughing force is neglected in this numerical model as it is much lesser than the other forces [15].

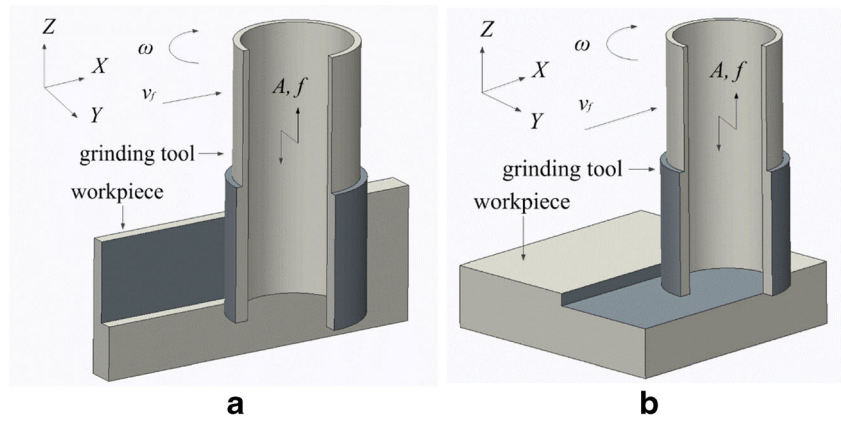
Then, the total side grinding force F_{SG} , normal force F_n , and tangential force F_t can be expressed respectively as Eqs. (3)–(4):

$$F_{SG} = F_{chip} + F_{friction} + F_{fracture} = F_n + F_t \quad (3)$$

$$\begin{aligned} F_n &= F_{nc} + F_{nr} + F_{na} \\ F_t &= F_{tc} + F_{tr} + F_{ta} \end{aligned} \quad (4)$$

where F_{nc} is normal component of chip formation force, F_{nr} is normal component of frictional force, F_{na} is normal component of fracture force, F_{tc} is tangential component of chip formation force, F_{tr} is tangential component of frictional force, and F_{ta} is tangential component of fracture force.

Fig. 1 Schematic diagram of two different machining modes: side grinding (a) and end grinding (b)



2.2.1 Dynamic motion of a single grain in side grinding

As shown in Fig. 4, in side grinding process, an abrasive grain cuts in at point B and out at point A, so the cutting depth a_p (mm) can be expressed as

$$a_p = R_o(1 - \cos\omega\Delta T) \tag{5}$$

where ΔT is the effective time between cutting in and out of the workpiece.

Considering $\omega\Delta T$ is close to 0, it can be simplified as

$$\cos\omega\Delta T = 1 - \frac{(\omega\Delta T)^2}{2} \tag{6}$$

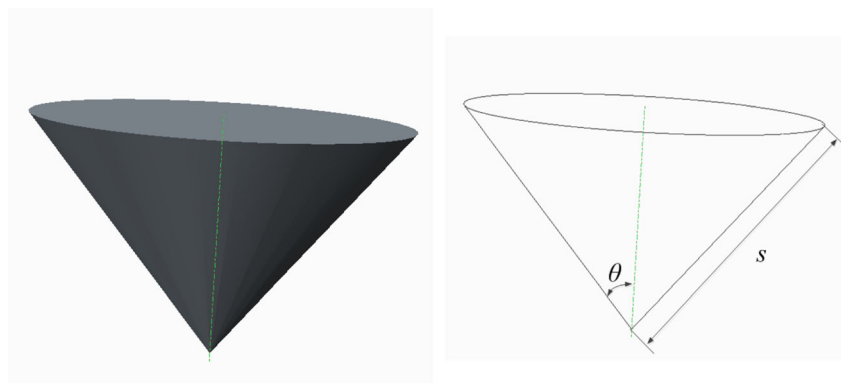
where $\omega = \frac{v_c}{R_o}$.

Substituting Eq. (6) into Eq. (5), the effective cutting time can be obtained

$$\Delta T = \frac{\sqrt{2a_p R_o}}{v_c} \tag{7}$$

where v_c is the linear speed of the grinding tool.

Fig. 2 Schematic diagram of an abrasive grain



In ultrasonic vibration assisted side grinding process, the geometric contact length l_a and dynamic contact length l_b can be calculated respectively:

$$l_a = \widehat{AB} = v_c\Delta T = \sqrt{2a_p R_o} \tag{8}$$

$$l_b = \int_0^{\Delta T} |v_{gt}| dt = \int_0^{\Delta T} \sqrt{(v_f + \omega R_o \cos(\omega t))^2 + (-\omega R_o \sin(\omega t))^2 + (2\pi f A \cos(2\pi f t))^2} dt \tag{9}$$

Setting $X = (v_f + v_c)t$, $Y = A \sin(2\pi f t)$, then l_b can also be expressed as

$$l_b = \int_0^l \sqrt{1 + \left(\frac{dY}{dX}\right)^2} dX = \int_0^l \sqrt{1 + \left(\frac{2\pi f A}{v_f + v_c} \cos\left(\frac{2\pi f}{v_f + v_c} X\right)\right)^2} dX \tag{10}$$

where $l = \int_0^{\Delta T} (v_f + v_c) dt \approx l_a$.

2.2.2 Chip formation force

The cutting process of a single grain of the tool is similar to the process of a single cutting tool in turning [16]. As shown in

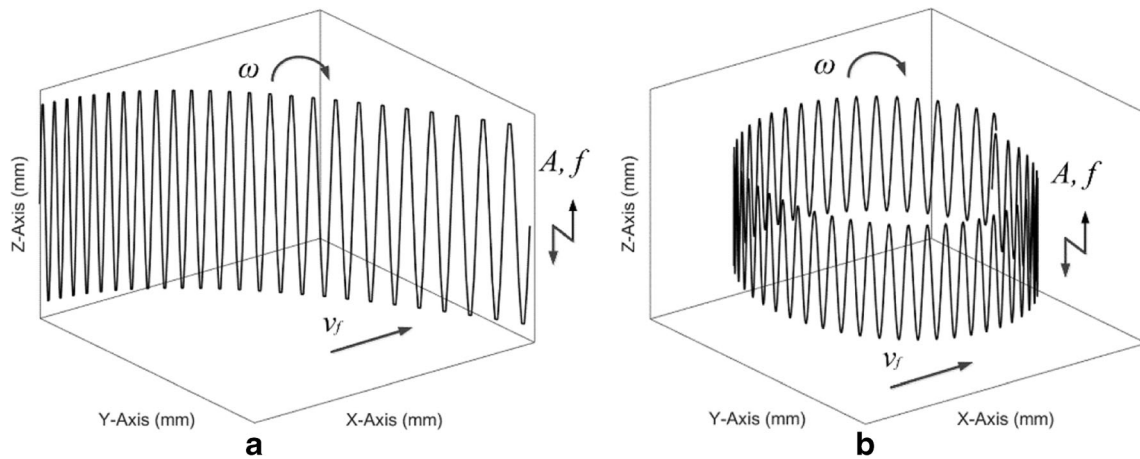


Fig. 3 Motion trajectories of grains on side (a) and end (b) surface of the grinding tool

Fig. 5, in the X–X cross-sectional area, grinding force of a single grain can be expressed as

$$dF_x = F_p dA_g \cos\theta \cos\psi \tag{11}$$

where F_p is the grinding force per unit area, ψ is the angle between grinding force direction, and X is the direction.

The center line of the grains points to the center of the grinding tool along the radius direction, then the contact area between a single grain and the workpiece can be expressed as

$$dA_g = \frac{1}{2} s^2 \sin\theta d\psi \tag{12}$$

Substituting Eq. (12) into Eq. (11),

$$dF_x = \frac{1}{2} s^2 F_p \sin\theta \cos\theta \cos\psi d\psi \tag{13}$$

Then the normal and tangential chip formation force of a single grain can be expressed as

$$\begin{aligned} dF_{tgc} &= dF_x \cos\theta \cos\psi = \frac{1}{2} s^2 F_p \sin\theta \cos^2\theta \cos^2\psi d\psi \\ dF_{ngc} &= dF_x \sin\theta = \frac{1}{2} s^2 F_p \sin^2\theta \cos\theta \cos\psi d\psi \end{aligned} \tag{14}$$

Under the influence of the ultrasonic vibration, as shown in Fig. 6, there exists an angle φ between grain motion direction and tangential direction, which can be expressed as

$$\varphi = \arctan \frac{A\omega \cos\omega t}{v_c} \tag{15}$$

Then the normal and tangential chip formation force of a single grain can be determined as

$$\begin{aligned} F_{ngc} &= \int_{-\pi/2+\varphi}^{\pi/2+\varphi} dF_{ngc} = F_p \bar{h}^2 \sin\theta \tan\theta \cos\varphi \\ F_{tgc} &= \int_{-\pi/2+\varphi}^{\pi/2+\varphi} dF_{tgc} = \frac{\pi}{4} F_p \bar{h}^2 \sin\theta \end{aligned} \tag{16}$$

where \bar{h} is the average cutting depth, i.e., undeformed chip thickness.

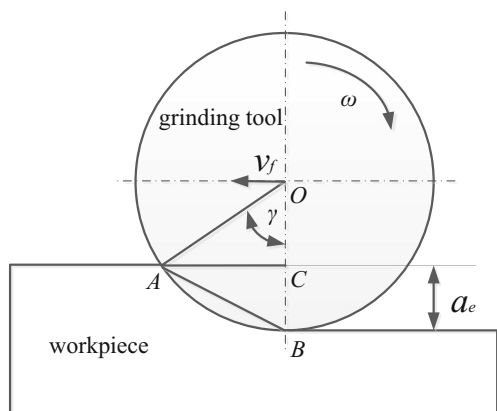


Fig. 4 Schematic diagram of side grinding process

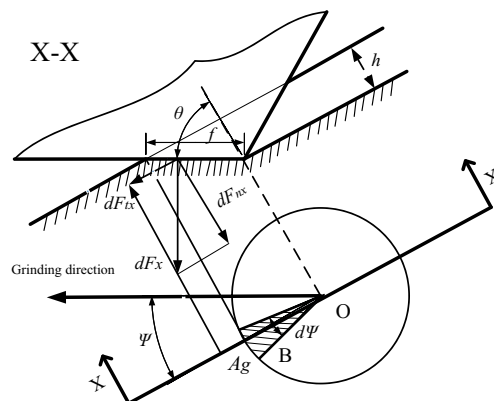


Fig. 5 Schematic diagram of force model of a single grain in side grinding

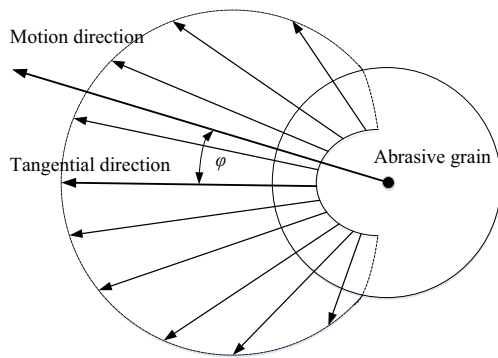


Fig. 6 Schematic diagram of φ between motion direction and tangential direction

Several research results [17, 18] show that the undeformed chip thickness can be described by Rayleigh’s probability density function, which is given by

$$f(h) = \begin{cases} (h/m^2)e^{-(h^2/2m^2)} & h \geq 0 \\ 0 & h < 0 \end{cases} \quad (17)$$

where m is a parameter that completely defines the probability density function, and it depends upon the cutting conditions, microstructure of grinding tool, and the properties of workpiece material. The expected value and standard deviation of the above function can be expressed as

$$E(h) = \sqrt{\frac{\pi}{2}}m \quad (18)$$

$$\sigma(h) = \sqrt{\frac{4-\pi}{2}}m \quad (19)$$

The expected value of undeformed chip thickness area A_{ct} can be expressed as

$$E(A_{ct}) = E(h^2)\tan\theta \quad (20)$$

Then the expected value of the total material removal volumes by all active grains can be expressed as

$$V_g = N_s E(A_{ct})l_b \quad (21)$$

where N_s is the number of active grains in the contact area which can be obtained according to the definition of abrasive concentration. Since abrasive particle is simplified as a regular cone, the number of active abrasive grains can be obtained by the following equation:

$$N_s = \left[\frac{0.88 \times 10^{-3} C_a}{\frac{1}{3}\pi(ssin\theta)^2s \cos\theta\rho} \right]^{2/3} bl_a = k \frac{C_a^{2/3}}{s^2} bl_a \quad (22)$$

where k is a constant, ρ is the density of the abrasive grain material, $\rho=3.52e-3$ g/mm³ for diamond, C_a is the abrasive concentration of the tool, and b is the cutting width.

In addition, the total material removal volumes can also be calculated as

$$V_g = a_p b v_f \Delta T \quad (23)$$

Substituting Eqs. (20) and (21) into Eq. (23), the expected value of h^2 can be obtained:

$$E(h^2) = \frac{a_p v_f \Delta T}{k \frac{C_a^{2/3}}{s^2} l_a l_b \tan\theta} \quad (24)$$

$E(h^2)$ can also be calculated as

$$E(h^2) = \int_0^\infty h^2 f(h) dh \quad (25)$$

Substituting Eqs. (17), (24), and (25) into Eq. (18), the undeformed chip thickness can be obtained:

$$\bar{h} = \sqrt{\frac{\pi a_p v_f}{4k \frac{C_a^{2/3}}{s^2} l_b v_c \tan\theta}} \quad (26)$$

Substituting Eq. (26) into Eq. (16), setting $C_1 = \frac{1}{8} F_p \sin\theta$ and $C_2 = \frac{\pi}{32} F_p \cos\theta$, the normal and tangential chip formation force can be determined by multiplying N_a

$$\begin{aligned} F_{nc} &= C_1 \frac{l_a v_f}{l_b n R_o} b a_p \cos\varphi \\ F_{tc} &= C_2 \frac{l_a v_f}{l_b n R_o} b a_p \end{aligned} \quad (27)$$

where C_1 and C_2 are experimental coefficients which can be determined through experiments in Sect. 4.1.1, and n is the spindle speed.

2.2.3 Frictional force

The wear of the grains in the flat area of the grinding wheel results in the frictional force [11, 16]. Assuming that SiC particles are not fractured in the rubbing process, the frictional behavior in grinding SiCp/Al composites is similar to that of metal materials. Hence, the normal and tangential frictional force can be expressed as follows:

$$\begin{aligned} F_{nr} &= N_s \tau p \\ F_{tr} &= \mu_g N_s \tau p \end{aligned} \quad (28)$$

where τ is the real contact area between the grinding tool and workpiece. p is the average contact pressure between the grinding tool and workpiece. μ_g is the coefficient of friction.

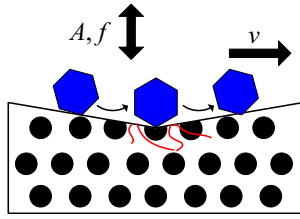


Fig. 7 Material removal mode: the interaction of impacting and erosion

In the geometric dynamics analysis of grinding grains, using parabola function to approximate the cutting path, the deviation between grinding wheel radius and the radius of curvature of the cutting path can be expressed as

$$\Delta = \frac{2v_f}{v_c R_o} \tag{29}$$

The average contact pressure between workpiece and abrasive grain wear plane approximately linearly increases with the deviation of curvature radius increases and can be expressed as

$$p = p_0 \Delta = \frac{2p_0 v_f}{v_c R_o} \tag{30}$$

where p_0 is the proportionality constant.

The average contact pressure between workpiece and abrasive grains wear plane varies with grinding parameters. Therefore, there is likely to exist elastic contact, elastic–plastic contact, or plastic contact. Therefore, the frictional coefficient also varies with the average contact pressure. According to the frictional binomial theorem, the frictional coefficient can be expressed as

$$\mu_g = \frac{\alpha}{p} + \beta \tag{31}$$

where α and β are coefficients which are determined by physical and mechanical properties of contact interface.

Substituting Eqs. (30)–(31) into Eq. (28), setting $C_3 = \frac{\sqrt{2}}{\pi} \tau k p_0$, $C_4 = \sqrt{2} \tau k$, and $C_5 = \frac{\sqrt{2}}{\pi} \tau \beta k p_0$, the total normal and tangential frictional forces can be expressed as

$$F_{nr} = C_3 \frac{v_f}{nR_o} \frac{C_a^{2/3}}{s^2} b \sqrt{\frac{a_p}{R_o}} \tag{32}$$

$$F_{tr} = C_4 \frac{C_a^{2/3}}{s^2} b \sqrt{a_p R_o} + C_5 \frac{v_f}{nR_o} \frac{C_a^{2/3}}{s^2} b \sqrt{\frac{a_p}{R_o}}$$

where C_3 – C_5 are experimental coefficients which can be determined through experiments in Sect. 4.1.1.

2.2.4 Fracture force

Cracking damage of the ceramic particle is assumed to be controlled by the stress in the particle and the statistical behavior of the strength of the particle [6, 10]. So based on Griffith theory, the change in the potential energy of the composite due to the debonding damage is a function of the volume fraction of the SiC particles and the material properties, as shown in Eq. (33):

$$G = \frac{dU}{dS} = \frac{K^2(1-\nu^2)}{E} \tag{33}$$

$$K^2 = \pi \sigma^2 l \tag{34}$$

$$dS = w dl \tag{35}$$

$$\sigma = \frac{K_{IC}}{\sqrt{d}} \tag{36}$$

where U is the strain energy, S is the change in interface crack area, K is stress intensity, ν is the Poisson’s ratio, E is the elastic modulus of the SiC particle, σ is the fracture stress of the SiC particle, l is the interface crack length, w is the initial interface crack width, K_{IC} is the fracture toughness of the SiC particle, and d is the size of the SiC particle.

The initial interface crack length l_i and the initial interface crack width w are assumed to be 1 μm ; the final crack length l_f

Fig. 8 Schematic diagram of the effective cutting time Δt in end grinding [21]

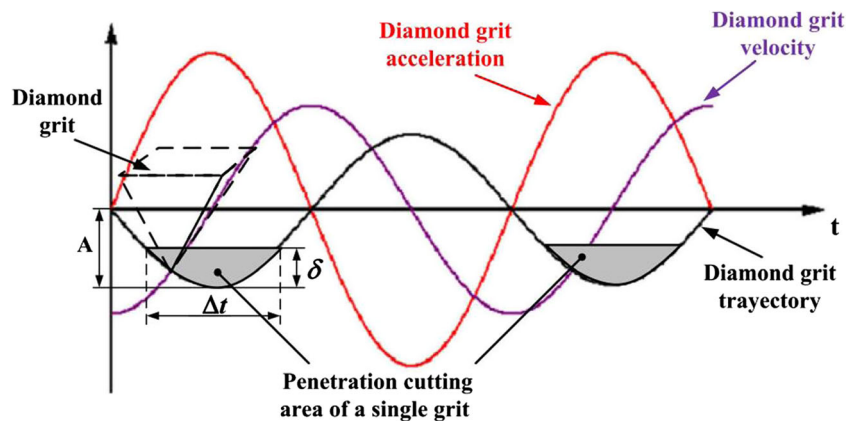


Table 1 Properties of the grinding tool used in experiments

Abrasive size s (μm)	Abrasive concentration Ca	Outer radius R_o (mm)	Inner radius R_i (mm)
75	100	30	20

is assumed to be equal to the circumference of the SiC particle [6, 10]. Hence, substituting Eqs. (34), (35), and (36) into Eq. (33), the strain energy consumed for fracture can be determined as follows:

$$U = \int_{l_i}^{l_f} \frac{\pi w K_{IC}^2 (1-v^2)}{Ed} dl \tag{37}$$

The research results of [11, 19] indicate that the fracture fraction of SiC particles is equal to the volume fraction; the number of fractured and debonding SiC particles per unit volume can be expressed as follows:

$$n_f = \frac{1}{\frac{4}{3}\pi\left(\frac{d}{2}\right)^3} v_d^2 \tag{38}$$

where v_d is the volume fraction of SiC particles.

According to the energy conservation law, the relationship between the fracture force and the strain energy consumed for fracture can be expressed as

$$F_{fracture} = n_f U b a_p \tag{39}$$

Substituting Eqs. (7), (23), (37), and (38) into Eq. (39), and setting $C_6 = n_f U \cos \theta$ and $C_7 = n_f U \sin \theta$, the total normal and tangential fracture forces can therefore be obtained:

$$\begin{aligned} F_{na} &= C_6 b a_p \\ F_{ta} &= C_7 b a_p \end{aligned} \tag{40}$$

where C_6 and C_7 are experimental coefficients of the normal and tangential fracture forces, respectively, which can be determined through experiments in Sect. 4.1.1.

Table 2 Experimental parameters for obtaining coefficients $C_1 \sim C_7$ in side grinding force model

Levels	Spindle speed n (rpm)	Feedrate v_f (mm/min)	Cutting depth a_p (mm)	Cutting width b (mm)
1	8000	100	0.05	1
2	10,000	150	0.1	3
3	12,000	200	0.15	5

Table 3 Coefficients $C_1 \sim C_7$ in side grinding force model

C_1	C_2	C_3	C_4	C_5	C_6	C_7
4519.5	1895.3763	331,949	150.514	45,835.2	9.1	19.1

2.2.5 The side grinding force model

Substituting Eqs. (4), (27), (32), and (40) into Eq. (3), the side grinding force model can be determined as follows:

$$F_{SG} = \begin{cases} C_1 \frac{l_a v_f}{l_b n R_o} b a_p \cos \varphi + C_3 \frac{v_f}{n R_o} \frac{C_a^{2/3}}{s^2} b \sqrt{\frac{a_p}{R_o}} + C_6 b a_p \\ C_2 \frac{l_a v_f}{l_b n R_o} b a_p + C_4 \frac{C_a^{2/3}}{s^2} b \sqrt{a_p R_o} + C_5 \frac{C_a^{2/3}}{s^2} \frac{v_f}{n R_o} b \sqrt{\frac{a_p}{R_o}} + C_7 b a_p \end{cases} \tag{41}$$

2.3 Development of end grinding force model

When the grinding tool feeds into SiCp/Al composites, an abrasive grain on the end face of the grinding tool is not in continuous contact with the workpiece due to ultrasonic vibration. So in the end grinding process, there are two different material removal modes between the abrasive grains and SiCp/Al composites—impact and erosion—as shown in Fig. 7. Due to the influence of the high vibration frequency, the impact mode is the major component in the end grinding process.

So the total end grinding force F_{EG} is mainly composed of the impact force F_{impact} and can be expressed as follows:

$$F_{EG} = F_{impact} \tag{42}$$

2.3.1 Dynamic motion of a single grain in end grinding

In each ultrasonic vibration cycle of the grinding tool, the abrasive grain makes contact with the workpiece only at a certain period of time, i.e., effective cutting time Δt , as shown in Fig. 8. It will take an abrasive grain on the end face of the

Table 4 Experimental parameters for obtaining coefficients $C_8 \sim C_{11}$ in end grinding force model

Levels	Spindle speed n (rpm)	Feedrate v_f (mm/min)	Cutting depth a_p (mm)
1	9000	100	0.04
2	12,000	150	0.06
3	15,000	200	0.08
4	18,000	250	0.1

Table 5 Coefficients C_8 – C_{11} in end grinding force model

C_8	C_9	C_{10}	C_{11}
55,436.8603	-0.738	0.218	0.165

grinding tool $\Delta t/2$ to move from $z=A-\delta$ to $z=A$. Δt can be calculated by the following equation [20]:

$$\Delta t = \frac{\delta}{2Af} \propto \frac{\delta}{Af} \tag{43}$$

2.3.2 Impact force

Several research results [22–24] indicate that SiCp/Al composites show different micro-properties with different indentation experiment conditions such as loading point, loading rate, loading value, and indentation depth. So, in this section, SiCp/Al composites are simplified as

an equivalent homogenous metal material with the same properties, hence the maximum impact force induced by the maximum penetration can be expressed by the following equation:

$$F_m = \frac{1}{2} \sigma_y \pi (\delta \sin \theta)^2 N_m \propto \delta^2 N_m \tag{44}$$

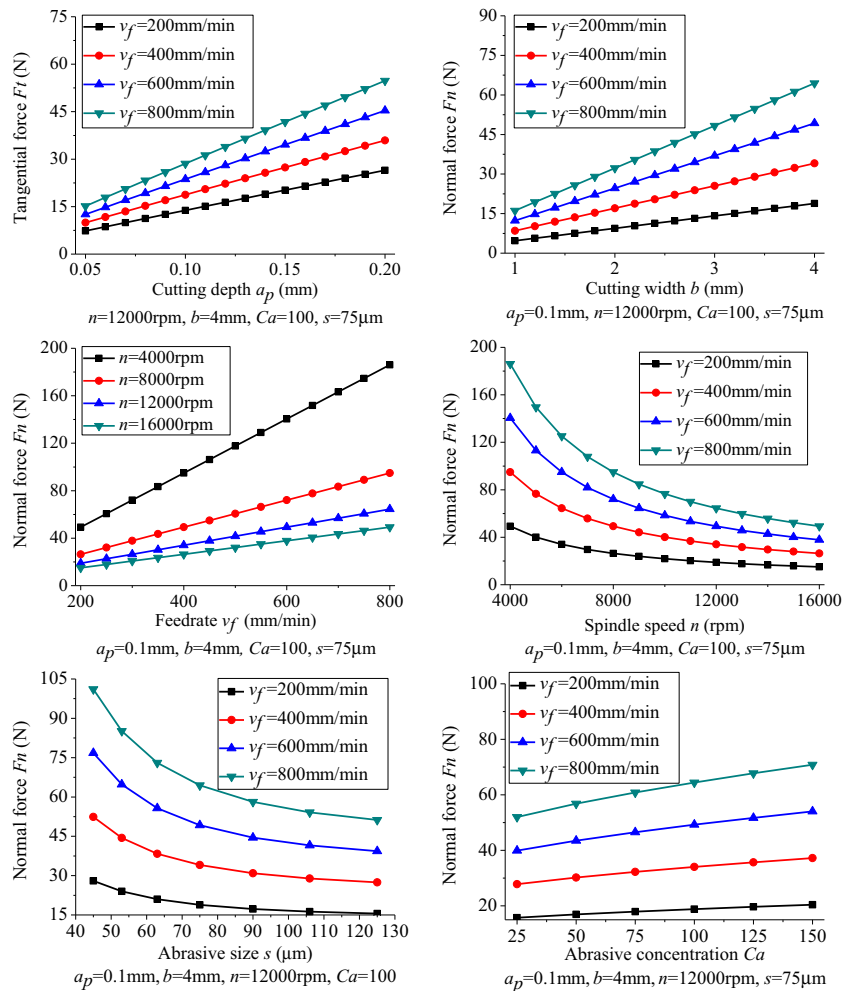
where σ_y is the compressive strength of the material, δ is the maximum penetration depth of an abrasive grain on the end face of the grinding tool, and N_m is the number of abrasive particles on the end face of the grinding tool which can be obtained by the following equation

$$N_m = k \frac{C_a^{2/3} \pi (R_o^2 - R_i^2)}{s^2} \propto \frac{C_a^{2/3}}{s^2} \tag{45}$$

Then, the average impact force in a vibration cycle can be calculated as follows:

$$F_{impact} = F_m f \Delta t \tag{46}$$

Fig. 9 Predicted relationship between the normal force and process variables



Substituting Eqs. (43), (44), and (45) into Eq. (46), the relationship between the impact force and the maximum penetration depth can be obtained:

$$F_{impact} \propto \frac{\delta^3 C_a^{2/3}}{A s^2} \tag{47}$$

2.3.3 Actual volume removed in a vibration cycle

Compared with the spindle speed, the feed speed is much lesser; this paper assumes that the influence of feed motion can be neglected in the calculation of effective cutting distance that an abrasive grain scratches during effective cutting time. So the effective cutting distance can be calculated by the following equation:

$$l_s = \frac{2\pi n R}{60} \Delta t \propto n \frac{\delta}{A f} \tag{48}$$

where R is the average radius of the tool and can be expressed as

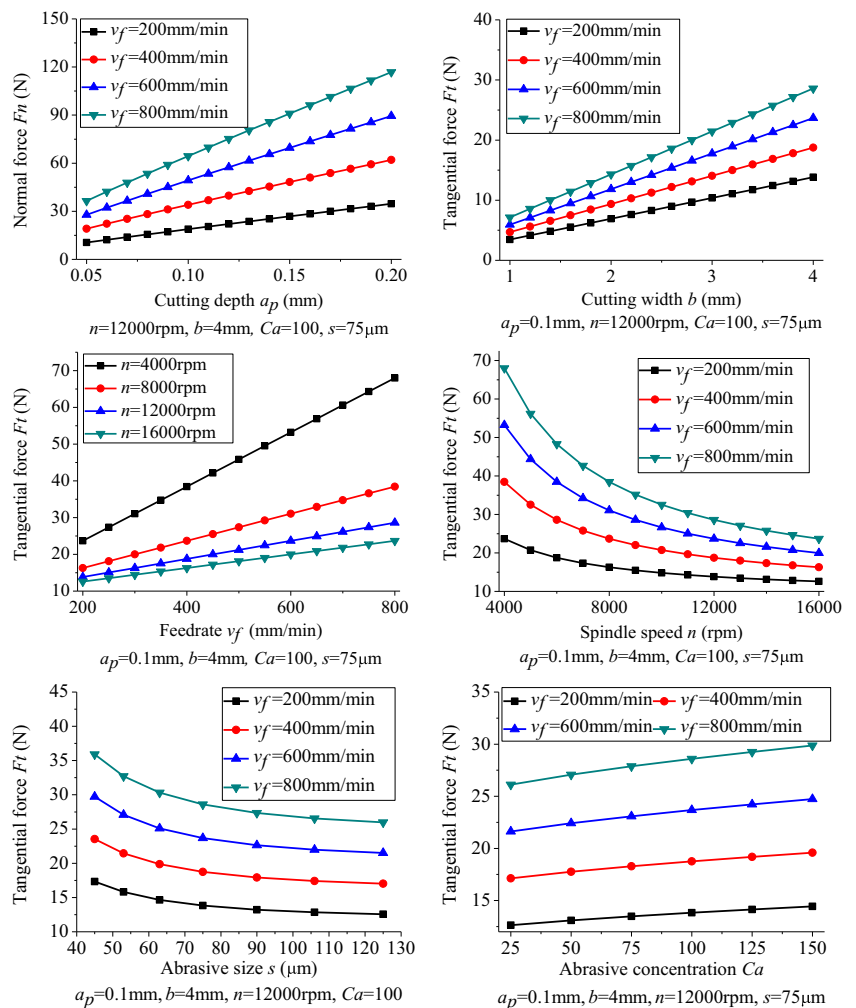
$$R = \frac{1}{2} (R_i + R_o) \tag{49}$$

At the same time, the abrasive grain scratches SiCp/Al composites when the penetration increases from 0 to δ and decreases to 0. So the volume of material removed by one abrasive grain in a vibration cycle can be described as a pyrometric cone and can be obtained from the following equation:

$$V_e = \frac{1}{3} l_s \delta^2 \tan \theta \propto n \frac{\delta^3}{A f} \tag{50}$$

Considering the interrelations among abrasive grains, the feed motion of the grinding tool, and the fracture of SiC particles, the actual volume of material removed in a vibration cycle is different from the theoretical volume. Assuming that the actual volume is in terms of the theoretical volume and

Fig. 10 Predicted relationship between the tangential force and process variables



cutting parameters, then the actual volume in a vibration cycle can be expressed as

$$V_m = c_8 n^{c_9} a_p^{c_{10}} v_f^{c_{11}} N_m V_e \alpha n^{c_9+1} a_p^{c_{10}} v_f^{c_{11}} \frac{C_a^{2/3} \delta^3}{s^2 Af} \quad (51)$$

In addition, actual volume of material removed in a vibration cycle can also be expressed as follows:

$$V_m = Abv_f \Delta t \alpha v_f \frac{\delta}{f} \quad (52)$$

2.3.4 The end grinding force model

Substituting Eqs. (48), (49), (50), and (52) into Eq. (51), the relationship between process parameters and the maximum penetration depth can be obtained:

$$\delta^2 \propto \frac{As^2}{C_a^{2/3} n^{c_9+1} a_p^{c_{10}} v_f^{c_{11}-1}} \quad (53)$$

Then the relationship between the impact force and process parameters can be obtained by solving Eqs. (47) and (53):

$$F_{impact} \propto \frac{A^{1/2} s}{C_a^{1/3} n^{3(c_9+1)/2} a_p^{3c_{10}/2} v_f^{3(c_{11}-1)/2}} \quad (54)$$

Setting C_8 as a constant coefficient, $C_9 = -3(c_9 + 1)/2$, $C_{10} = -3c_{10}/2$, and $C_{11} = -3(c_{11} - 1)/2$, the end grinding force model can be determined as follows:

$$F_{EG} = \frac{C_8 A^{1/2} s}{C_a^{1/3}} n^{C_9} a_p^{C_{10}} v_f^{C_{11}} \quad (55)$$

where $C_8 \sim C_{11}$ are experimental coefficients which can be determined through experiments in Sect. 4.1.2.

Fig. 11 Predicted relationship between the axial force and process variables

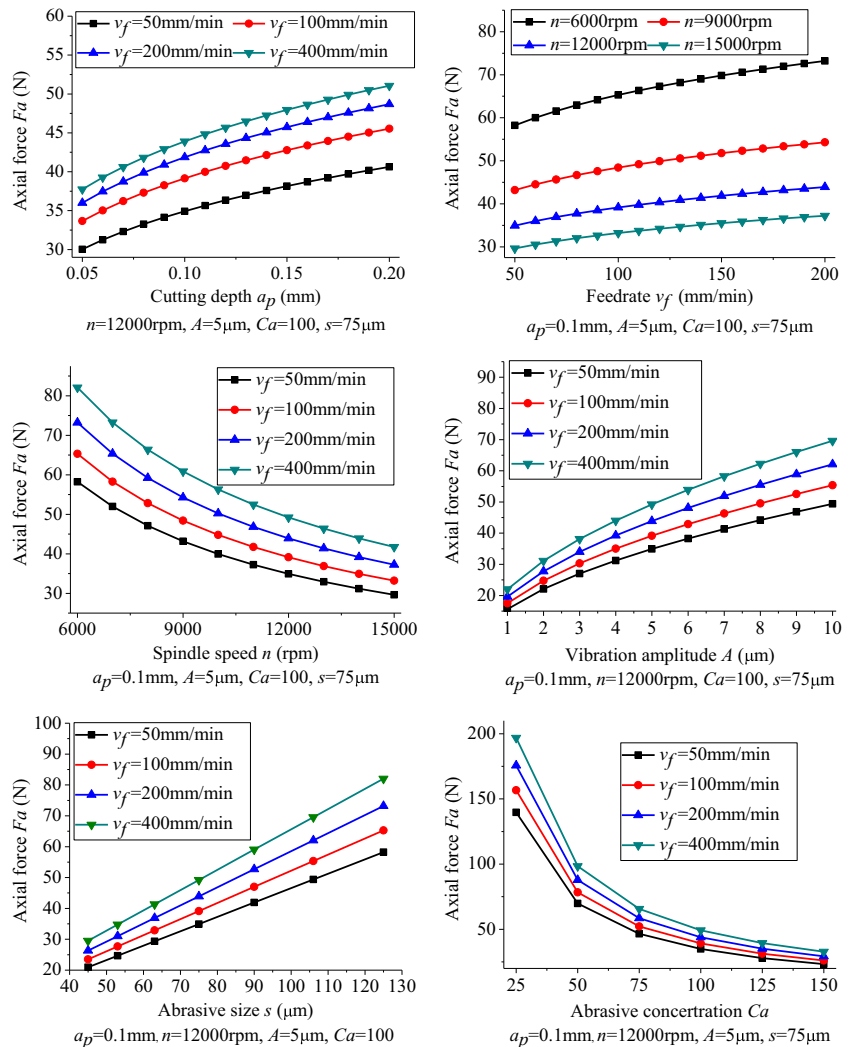
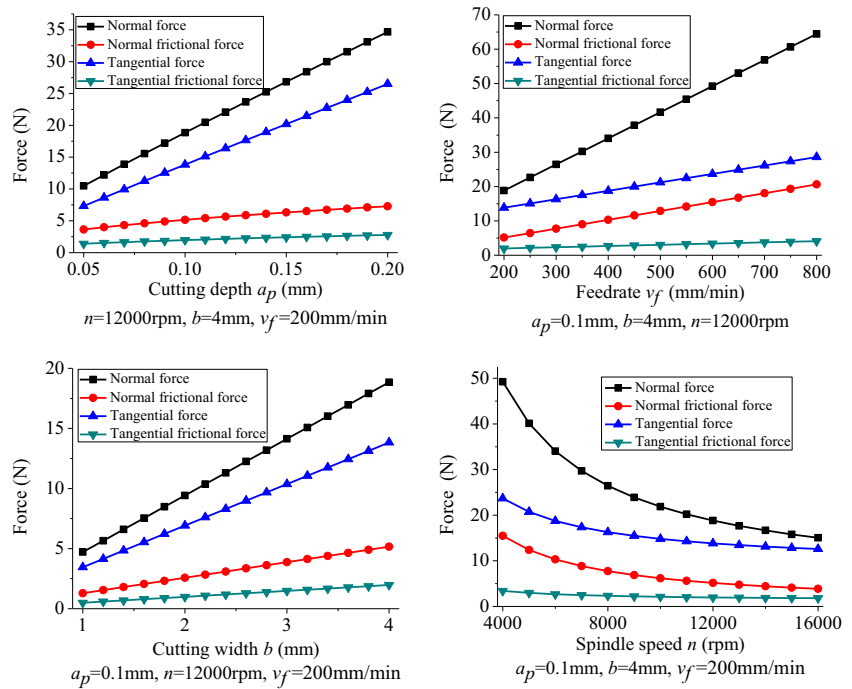


Fig. 12 Comparisons of the frictional force, normal force, and tangential force



3 Experimental setup

Ultrasonic vibration assisted grinding experiments were conducted on an ultrasonic vibration machine center (DMG Ultrasonic70-5 linear), which consisted a numerical control system, an ultrasonic spindle system, a data acquisition system, and a coolant system. The maximum spindle speed was 18,000 rpm. The frequency and amplitude supplied to the tool in the z direction were about 30 kHz and 5 μm , respectively. The grinding tool with metal-bonded diamond abrasives was provided by SCHOTT Company, and its properties were listed in Table 1. The grinding forces were measured by a three-component dynamometer type 9257B produced by Kistler Instrument Corporation. As the measured cutting forces are time-dependent and not constant in machining, especially at the moment of cut-in and cut-out, average values of cutting forces measured in the middle stage of the machining process are used in this work.

The workpiece material was 45 % SiCp/Al2024 composites. The average diameter of SiC particles was 5 μm .

Table 6 Process variables of validation experiments for side grinding force model

Process variables	Values
Spindle speed n (rpm)	4000, 6000, 8000, 10,000, 12,000, 14,000, 16,000
Feedrate v_f (mm/min)	200, 300, 400, 500, 600, 700, 800
Cutting depth a_p (mm)	0.05, 0.1, 0.15, 0.2, 0.25, 0.3, 0.35
Cutting width b (mm)	1, 1.5, 2, 2.5, 3, 3.5, 4

4 Results and discussion

4.1 Determination of coefficients in the proposed model

4.1.1 Determination of coefficients in side grinding model

The experimental coefficients $C_1 \sim C_7$ could be determined by four groups of experimental data by solving linear equations. To make the model representative for all possible combinations of process parameters which consisted of spindle speed n , feedrate v_f , cutting depth a_p , and cutting width b , an orthogonal experiment based on four factors with three levels was conducted, as listed in Table 2.

With the parameter spindle speed large enough, $\frac{2\pi f A}{v_f + v_c}$ is close to 0 (when n is equal to the minimum spindle speed of 8000 rpm with neglected v_f , it has the maximum value of 0.0375). So according to Eq. (10), it can be assumed that $l_b = l_a$. For the same reason, it can be assumed that $\cos \varphi = 1$. Hence, the side grinding force model can be simplified as follows:

$$F_{SG} = \begin{cases} C_1 \frac{v_f}{nR_o} b a_p + C_3 \frac{v_f}{nR_o} \frac{C_a^{2/3}}{s^2} b \sqrt{\frac{a_p}{R_o}} + C_6 b a_p \\ C_2 \frac{v_f}{nR_o} b a_p + C_4 \frac{C_a^{2/3}}{s^2} b \sqrt{a_p R_o} + C_5 \frac{v_f}{nR_o} \frac{C_a^{2/3}}{s^2} b \sqrt{\frac{a_p}{R_o}} + C_7 b a_p \end{cases} \quad (56)$$

Then each experiment was conducted thrice; the averages of grinding forces were substituted into Eq. (56), and the

Table 7 Process variables of validation experiments for end grinding force model

Process variables	Values
Spindle speed n (rpm)	6000, 7500, 9000, 10,500, 12,000, 13,500, 15,000
Feedrate v_f (mm/min)	50, 100, 150, 200, 250, 300, 350
Cutting depth a_p (mm)	0.05, 0.1, 0.15, 0.2, 0.25, 0.3, 0.35
Cutting width b (mm)	6

coefficients $C_1 \sim C_7$ determined through least square estimation (LSE), as listed in Table 3.

4.1.2 Determination of coefficients in end grinding force model

An orthogonal experiment based on three factors with four levels was conducted to determine experimental coefficients $C_8 \sim C_{11}$, as listed in Table 4.

Then each experiment was conducted thrice; the averages of grinding forces were substituted into Eq. (55), and the coefficients $C_8 \sim C_{11}$ determined through LSE, as listed in Table 5.

4.2 Predicted influences of process variables on grinding force

The predicted relationships between side grinding force (the normal force and tangential force) and process variables are plotted in Figs. 9 and 10 while the predicted

relationships between end grinding force (the axial force) and process variables are plotted in Fig. 11.

Figures 9, 10, and 11 show that all theoretical forces (the normal, tangential, and axial force) nonlinearly decrease with an increase of the spindle speed and approximately linearly increase as the cutting depth and feedrate increase. When the cutting width is increased, the normal force and tangential force also show an approximately linearly increase.

In side grinding process, spindle speed and feedrate have a larger effect on the side grinding force compared with cutting depth and cutting width, especially with the increase of feedrate or decrease of spindle speed, in which both the normal force and tangential force increase obviously.

Figures 9 and 10 also show that the normal force and tangential force vary slightly with the tool parameters (abrasive concentration and size). According to Eq. (41), the tool parameters only have an effect on frictional force which is much lesser than the normal force and tangential force, as shown in Fig. 12. This may be the reason why compared with the process parameters, the tool parameters have a less effect on the side grinding force.

Vibration parameter has the least influence in the side grinding force model. Eqs. (15) and (41) show that only chip formation force in the normal direction is influenced by vibration parameter (vibration amplitude), and as mentioned in Sect. 4.1.1, the excessive spindle speed will weaken the influence of the ultrasonic vibration.

Figure 11 shows that vibration parameters and tool parameters have a larger effect on the end grinding force model

Fig. 13 Predicted and experimental results of the normal force and tangential force

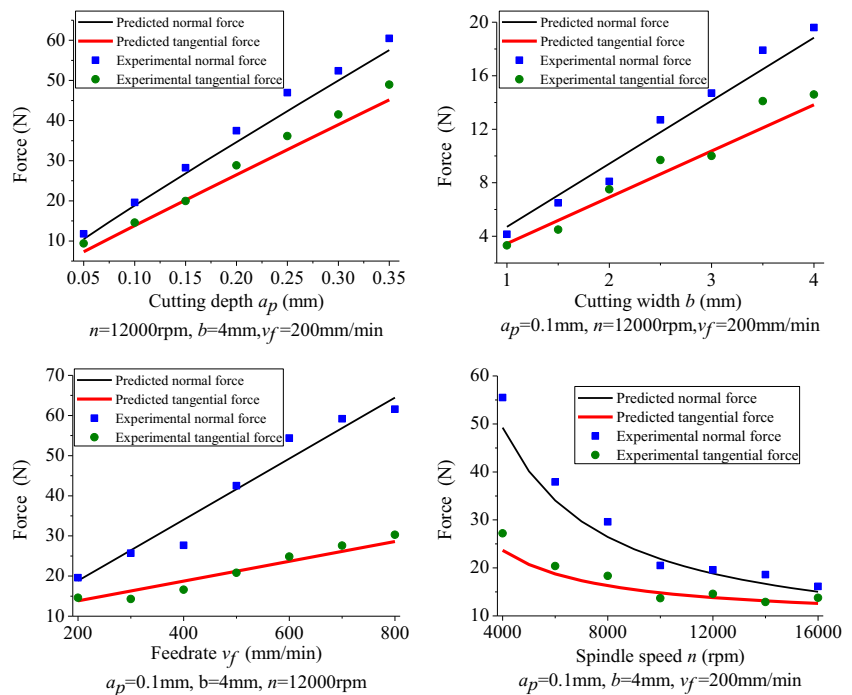
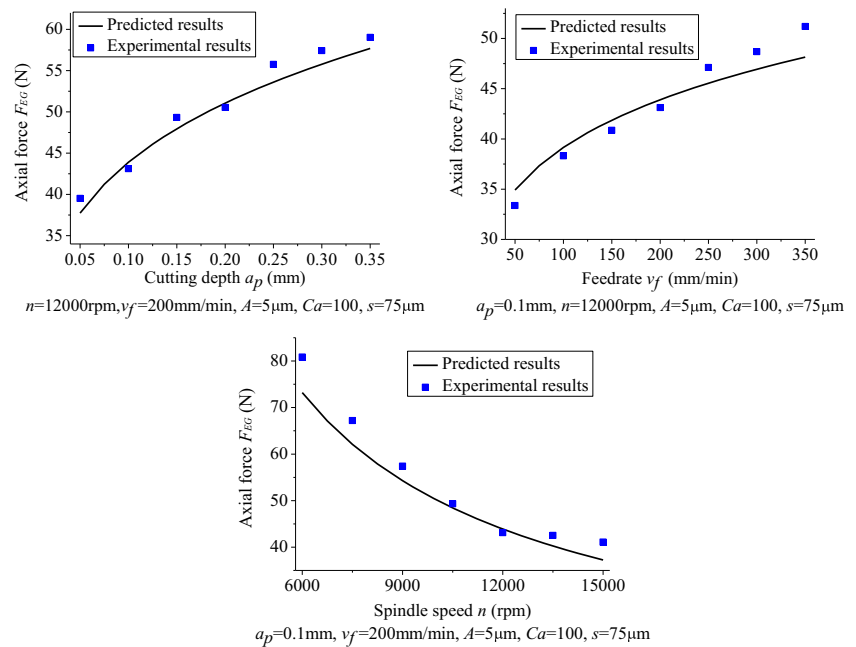


Fig. 14 Predicted and experimental results of the axial force



compared with the side grinding force model due to the coaxial relations between the vibration direction and the axial force direction. For this reason, vibration parameters and tool parameters have a direct effect on the impact force.

4.3 Validation of the proposed grinding force model

The validation experimental setup was the same as shown in Sect. 3, and the process variables for the comparison of predicted values and experimental values of side grinding force model and end grinding force model were listed in Tables 6 and 7, respectively. Each variable was taken in seven levels while keeping other variables constant. Experimental results and predicted results were compared in Figs. 13 and 14.

Figures 13 and 14 showed that the predicted results of the normal force, tangential force, and axial force were found to agree well with the experimental results. It can also be seen that in most cases, the predicted results were smaller than the experimental results. This was due to the fact that in the proposed grinding force model, the ploughing force and erosion force are neglected in side grinding and end grinding, respectively. The average percentage of errors between experimental results and predicted results in the normal force, tangential force, and axial force were 8.6, 11.7, and 5 %, respectively.

5 Conclusions

This paper presents a mechanics model for predicting grinding forces in ultrasonic vibration assisted grinding

SiCp/Al composites. It consists of side grinding force model and end grinding force model.

In the side grinding force model, the major components are the normal force and tangential force. They can be subdivided into chip formation force, frictional force, and fracture force. In contrast, the axial force developed based on the indentation theory is the major component in end grinding force model.

Based on the proposed model, the relationship between grinding forces and process variables are predicted. The predicted trends show that in side grinding process, both the normal and tangential forces decrease with an increase in the spindle speed and abrasive size and rise with an increase in the cutting depth, cutting width, feedrate, and abrasive concentration. In end grinding process, the axial force increases with a reduction in the spindle speed and abrasive concentration and rises with an increase in the cutting depth, feedrate, vibration amplitude, and abrasive size.

Two groups of single factor experiments were conducted to verify the proposed model, and experimental results are found to agree well with the predicted results. The average percentages of errors between experimental results and predicted results in the normal force, tangential force, and axial force were 8.6, 11.7, and 5 % respectively. Therefore, this model can be used for predicting the grinding forces effectively in ultrasonic vibration assisted grinding of SiCp/Al composites.

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